



## IGBT

High speed DuoPack: IGBT in Trench and Fieldstop technology  
with soft, fast recovery anti-parallel diode

## IKW30N60H3

600V high speed switching series third generation



A large, stylized graphic element in the background features a central grey circle with a red ribbon-like shape winding around it. The background is a light blue gradient with some white steps or stairs visible at the bottom.

# SKYTECH

ELECTRONIC

Data sheet

Industrial Power Control

published by **WWW.SKYTECH.IR**

High speed DuoPack: IGBT in Trench and Fieldstop technology with soft, fast recovery anti-parallel diode

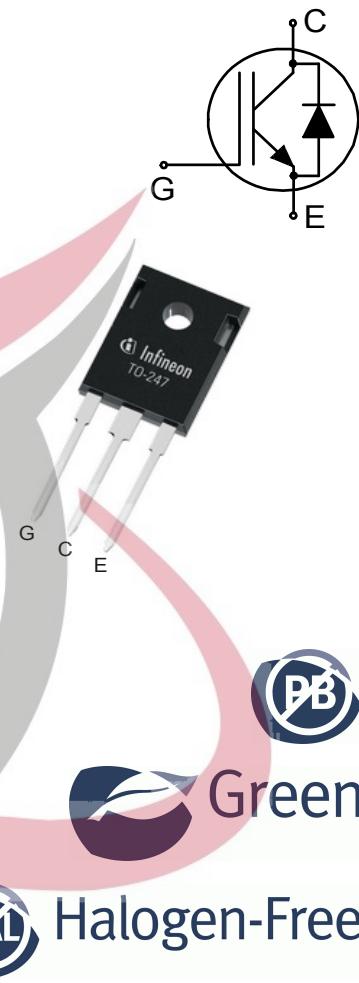
#### Features:

TRENCHSTOP™ technology offering

- very low  $V_{CEsat}$
- low EMI
- Very soft, fast recovery anti-parallel diode
- maximum junction temperature 175°C
- qualified according to JEDEC for target applications
- Pb-free lead plating; RoHS compliant
- complete product spectrum and PSpice Models:  
<http://www.infineon.com/igbt/>

#### Applications:

- uninterruptible power supplies
- welding converters
- converters with high switching frequency



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#### Key Performance and Package Parameters

Type	$V_{CE}$	$I_c$	$V_{CEsat}, T_{vj}=25^\circ\text{C}$	$T_{vjmax}$	Marking	Package
IKW30N60H3	600V	30A	1.95V	175°C	K30H603	PG-T0247-3

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**Maximum ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_{vj} \geq 25^\circ\text{C}$	$V_{CE}$	600	V
DC collector current, limited by $T_{vjmax}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	$I_C$	60.0 30.0	A
Pulsed collector current, $t_p$ limited by $T_{vjmax}$	$I_{Cpuls}$	120.0	A
Turn off safe operating area $V_{CE} \leq 600\text{V}$ , $T_{vj} \leq 175^\circ\text{C}$ , $t_p = 1\mu\text{s}$	-	120.0	A
Diode forward current, limited by $T_{vjmax}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	$I_F$	30.0 15.0	A
Diode pulsed current, $t_p$ limited by $T_{vjmax}$	$I_{Fpuls}$	120.0	A
Gate-emitter voltage	$V_{GE}$	$\pm 20$	V
Short circuit withstand time $V_{GE} = 15.0\text{V}$ , $V_{CC} \leq 400\text{V}$ Allowed number of short circuits < 1000 Time between short circuits: $\geq 1.0\text{s}$ $T_{vj} = 150^\circ\text{C}$	$t_{SC}$	5	$\mu\text{s}$
Power dissipation $T_C = 25^\circ\text{C}$ Power dissipation $T_C = 100^\circ\text{C}$	$P_{tot}$	187.0 94.0	W
Operating junction temperature	$T_{vj}$	-40...+175	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55...+150	$^\circ\text{C}$
Soldering temperature, wave soldering 1.6 mm (0.063 in.) from case for 10s		260	$^\circ\text{C}$
Mounting torque, M3 screw Maximum of mounting processes: 3	M	0.6	Nm

**Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
<b>Characteristic</b>				
IGBT thermal resistance, junction - case	$R_{th(j-c)}$		0.80	K/W
Diode thermal resistance, junction - case	$R_{th(j-c)}$		1.90	K/W
Thermal resistance junction - ambient	$R_{th(j-a)}$		40	K/W

Electrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Static Characteristic</b>						
Collector-emitter breakdown voltage	$V_{(\text{BR})\text{CES}}$	$V_{\text{GE}} = 0\text{V}, I_{\text{C}} = 2.00\text{mA}$	600	-	-	V
Collector-emitter saturation voltage	$V_{\text{CEsat}}$	$V_{\text{GE}} = 15.0\text{V}, I_{\text{C}} = 30.0\text{A}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 125^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	1.95	2.40	V
Diode forward voltage	$V_F$	$V_{\text{GE}} = 0\text{V}, I_F = 15.0\text{A}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 125^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	1.65	2.05	V
Gate-emitter threshold voltage	$V_{\text{GE(th)}}$	$I_{\text{C}} = 0.43\text{mA}, V_{\text{CE}} = V_{\text{GE}}$	4.1	5.1	5.7	V
Zero gate voltage collector current	$I_{\text{CES}}$	$V_{\text{CE}} = 600\text{V}, V_{\text{GE}} = 0\text{V}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	-	40.0 2000.0	$\mu\text{A}$
Gate-emitter leakage current	$I_{\text{GES}}$	$V_{\text{CE}} = 0\text{V}, V_{\text{GE}} = 20\text{V}$	-	-	100	nA
Transconductance	$g_{\text{fs}}$	$V_{\text{CE}} = 20\text{V}, I_{\text{C}} = 30.0\text{A}$	-	16.0	-	S

Electrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified

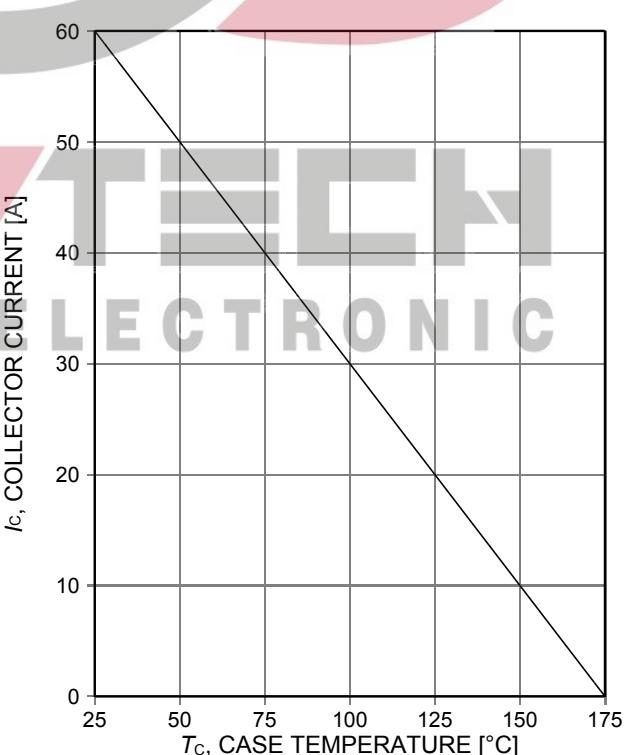
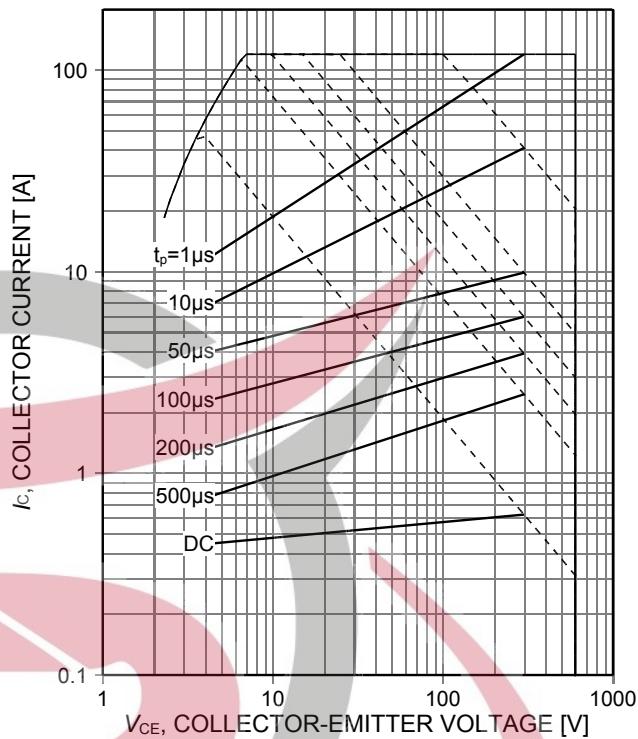
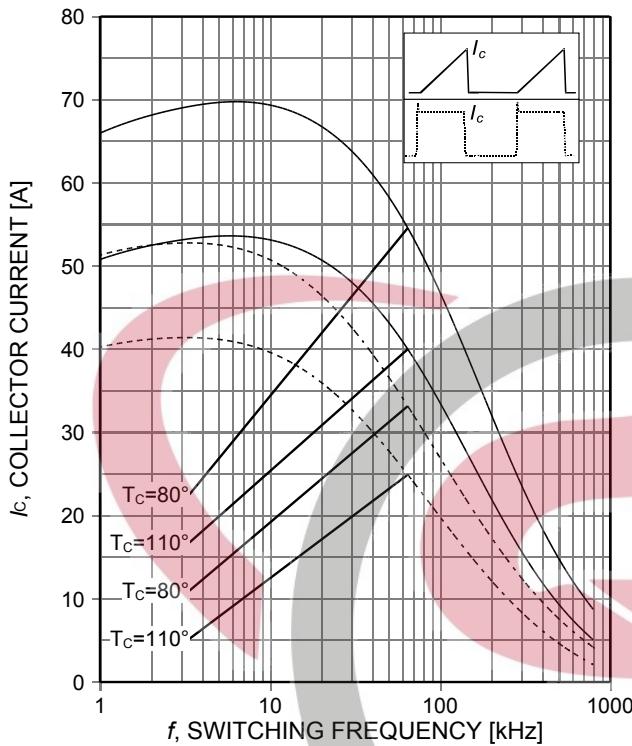
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Dynamic Characteristic</b>						
Input capacitance	$C_{\text{ies}}$		-	1630	-	pF
Output capacitance	$C_{\text{oes}}$	$V_{\text{CE}} = 25\text{V}, V_{\text{GE}} = 0\text{V}, f = 1\text{MHz}$	-	107	-	
Reverse transfer capacitance	$C_{\text{res}}$		-	50	-	
Gate charge	$Q_G$	$V_{\text{CC}} = 480\text{V}, I_{\text{C}} = 30.0\text{A}, V_{\text{GE}} = 15\text{V}$	-	165.0	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$		-	13.0	-	nH
Short circuit collector current Max. 1000 short circuits Time between short circuits: $\geq 1.0\text{s}$	$I_{\text{C(SC)}}$	$V_{\text{GE}} = 15.0\text{V}, V_{\text{CC}} \leq 400\text{V}, t_{\text{SC}} \leq 5\mu\text{s}, T_{vj} = 150^\circ\text{C}$	-	160	-	A

**Switching Characteristic, Inductive Load**

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic, at <math>T_{vj} = 25^\circ\text{C}</math></b>						
Turn-on delay time	$t_{d(on)}$	$T_{vj} = 25^\circ\text{C}$ , $V_{CC} = 400\text{V}$ , $I_C = 30.0\text{A}$ , $V_{GE} = 0.0/15.0\text{V}$ , $r_G = 10.5\Omega$ , $L_\sigma = 95\text{nH}$ , $C_\sigma = 67\text{pF}$ $L_\sigma$ , $C_\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	21	-	ns
Rise time	$t_r$		-	33	-	ns
Turn-off delay time	$t_{d(off)}$		-	207	-	ns
Fall time	$t_f$		-	22	-	ns
Turn-on energy	$E_{on}$		-	0.94	-	mJ
Turn-off energy	$E_{off}$		-	0.44	-	mJ
Total switching energy	$E_{ts}$		-	1.38	-	mJ
Diode reverse recovery time	$t_{rr}$	$T_{vj} = 25^\circ\text{C}$ , $V_R = 400\text{V}$ , $I_F = 15.0\text{A}$ , $di_F/dt = 1000\text{A}/\mu\text{s}$	-	38	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.32	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	12.0	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-765	-	$\text{A}/\mu\text{s}$

**Switching Characteristic, Inductive Load**

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic, at <math>T_{vj} = 175^\circ\text{C}</math></b>						
Turn-on delay time	$t_{d(on)}$	$T_{vj} = 175^\circ\text{C}$ , $V_{CC} = 400\text{V}$ , $I_C = 30.0\text{A}$ , $V_{GE} = 0.0/15.0\text{V}$ , $r_G = 10.5\Omega$ , $L_\sigma = 95\text{nH}$ , $C_\sigma = 67\text{pF}$ $L_\sigma$ , $C_\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	20	-	ns
Rise time	$t_r$		-	30	-	ns
Turn-off delay time	$t_{d(off)}$		-	239	-	ns
Fall time	$t_f$		-	23	-	ns
Turn-on energy	$E_{on}$		-	1.12	-	mJ
Turn-off energy	$E_{off}$		-	0.60	-	mJ
Total switching energy	$E_{ts}$		-	1.72	-	mJ
Diode reverse recovery time	$t_{rr}$	$T_{vj} = 175^\circ\text{C}$ , $V_R = 400\text{V}$ , $I_F = 15.0\text{A}$ , $di_F/dt = 1000\text{A}/\mu\text{s}$	-	117	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	1.08	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	16.6	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-530	-	$\text{A}/\mu\text{s}$



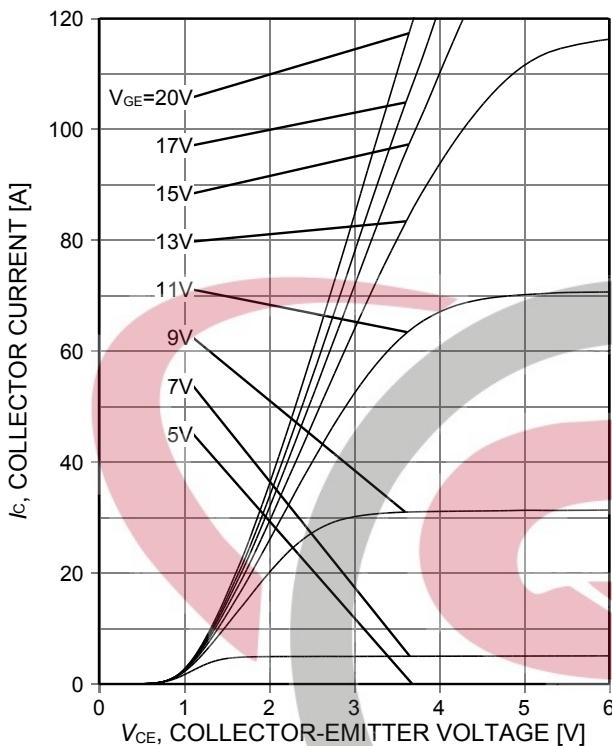


Figure 5. **Typical output characteristic**  
( $T_j=25^\circ\text{C}$ )

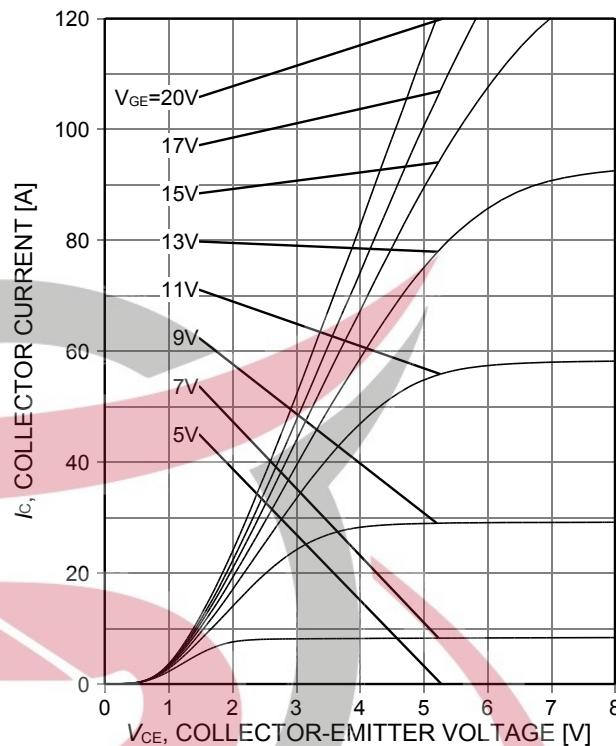


Figure 6. **Typical output characteristic**  
( $T_j=175^\circ\text{C}$ )

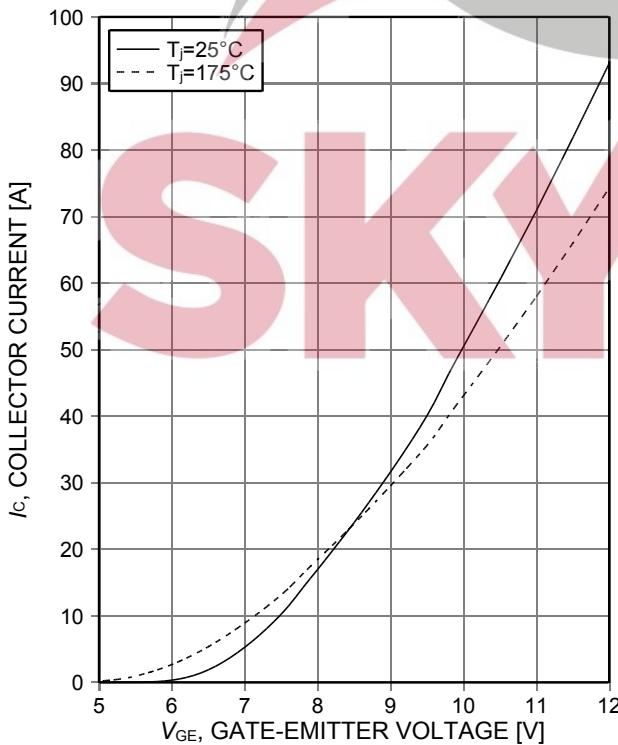


Figure 7. **Typical transfer characteristic**  
( $V_{CE}=20\text{V}$ )

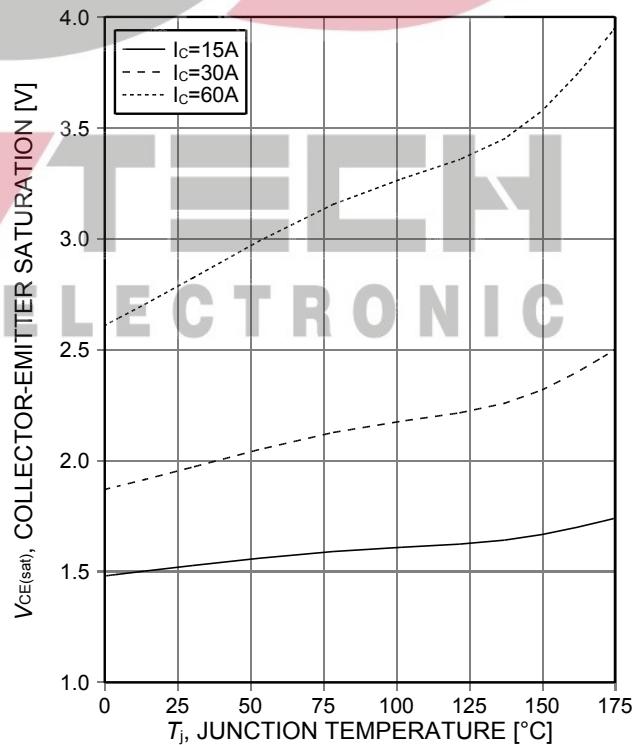


Figure 8. **Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE}=15\text{V}$ )

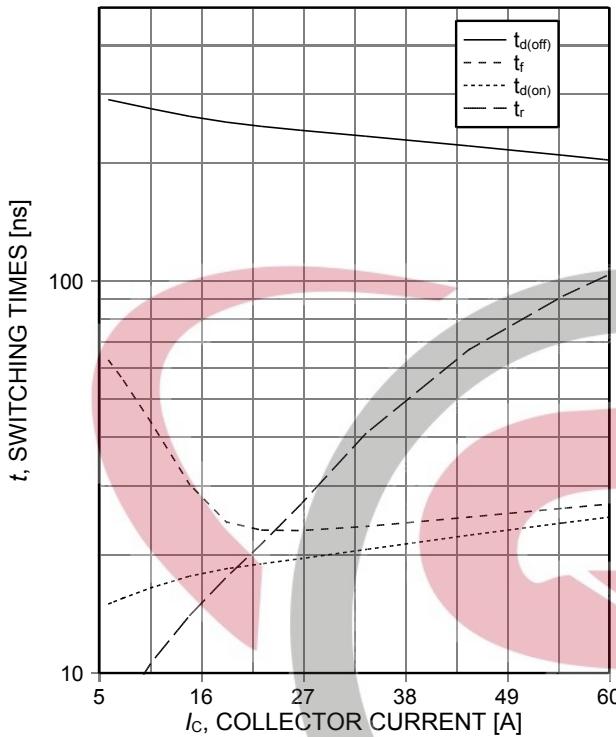


Figure 9. Typical switching times as a function of collector current  
(ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  
 $r_G=10,5\Omega$ , test circuit in Fig. E)

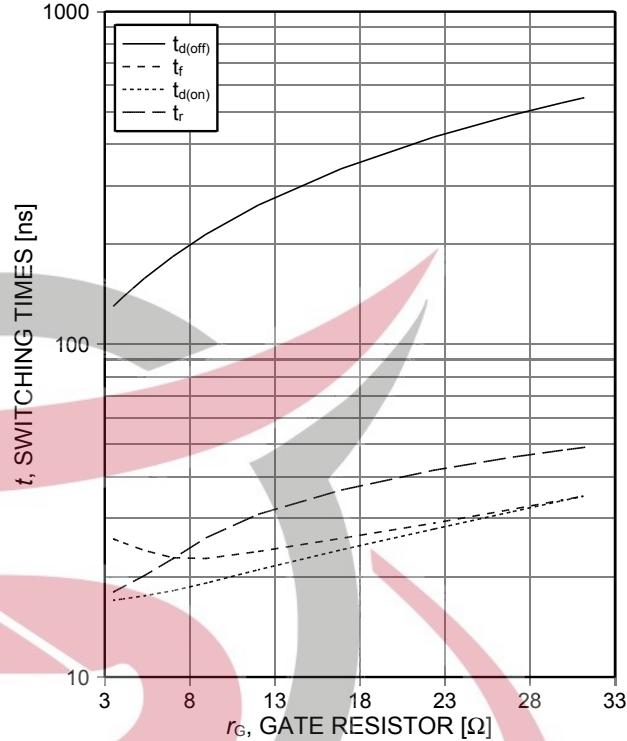


Figure 10. Typical switching times as a function of gate resistor  
(ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  
 $I_c=30\text{A}$ , test circuit in Fig. E)

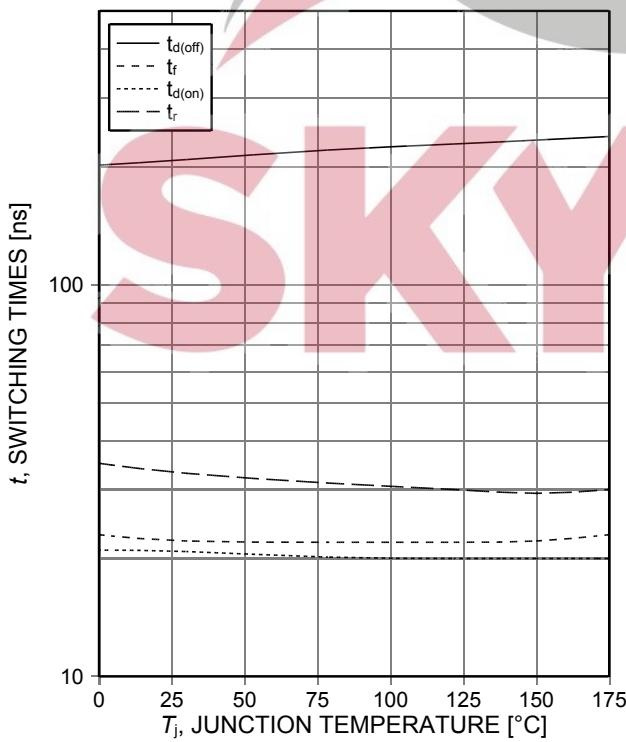


Figure 11. Typical switching times as a function of junction temperature  
(ind. load,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_c=30\text{A}$ ,  
 $r_G=10,5\Omega$ , test circuit in Fig. E)

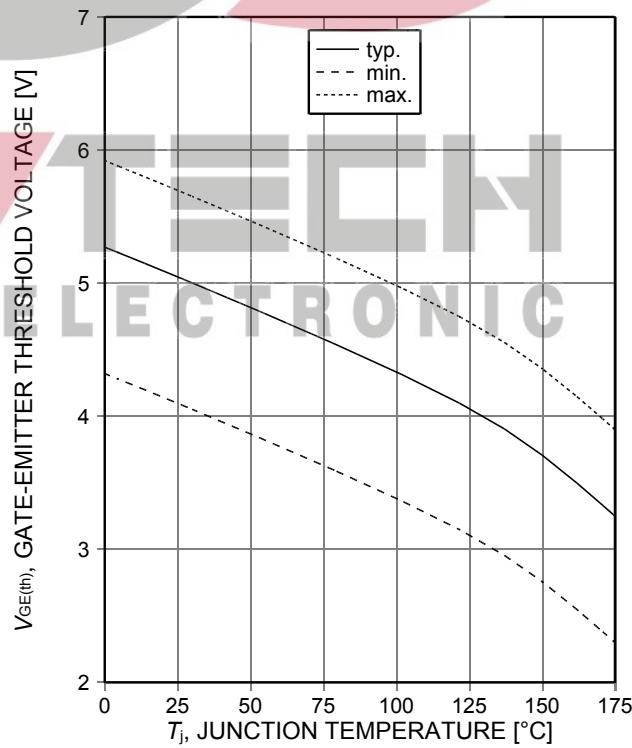


Figure 12. Gate-emitter threshold voltage as a function of junction temperature  
( $I_c=0.43\text{mA}$ )

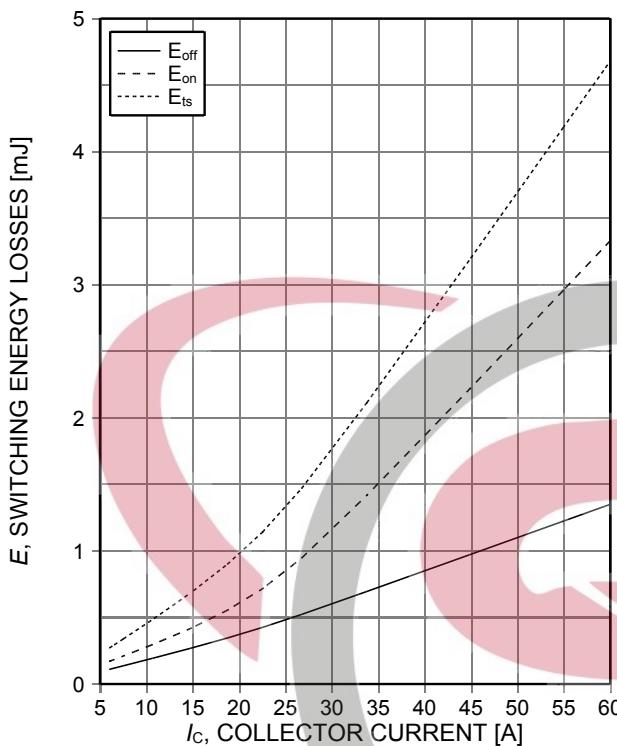


Figure 13. Typical switching energy losses as a function of collector current  
(ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $r_G=10,5\Omega$ , test circuit in Fig. E)

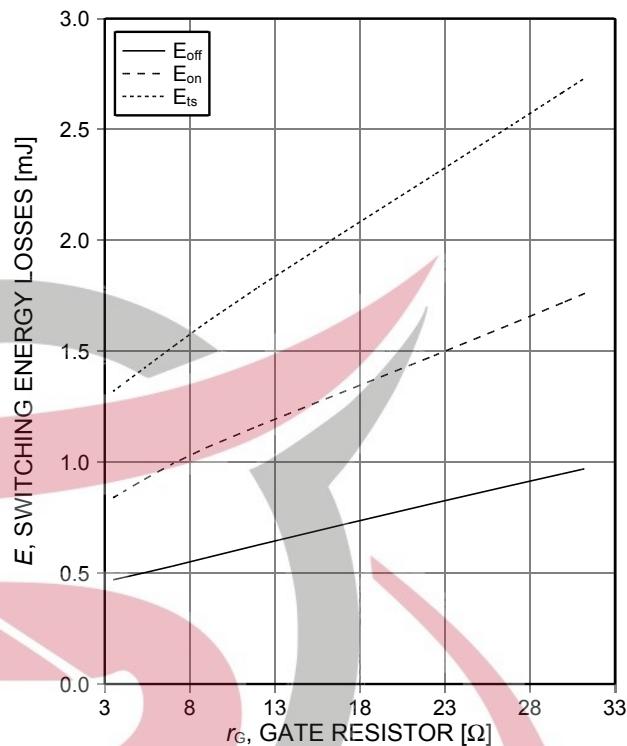


Figure 14. Typical switching energy losses as a function of gate resistor  
(ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_c=30\text{A}$ , test circuit in Fig. E)

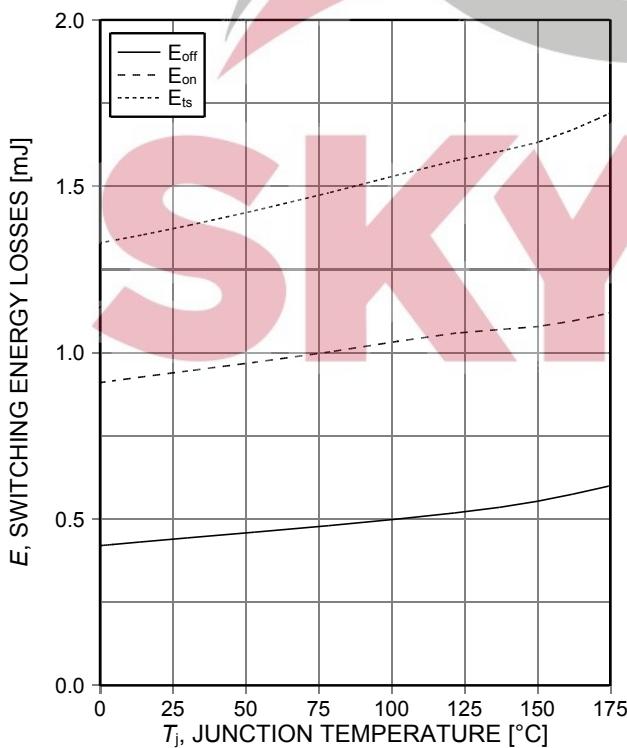


Figure 15. Typical switching energy losses as a function of junction temperature  
(ind load,  $V_{CE}=400\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_c=30\text{A}$ ,  $r_G=10,5\Omega$ , test circuit in Fig. E)

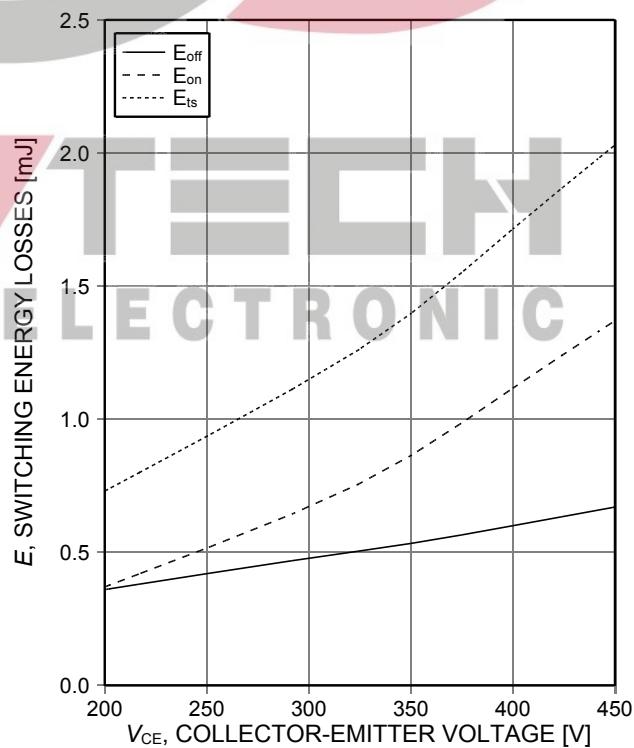


Figure 16. Typical switching energy losses as a function of collector-emitter voltage  
(ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_c=30\text{A}$ ,  $r_G=10,5\Omega$ , test circuit in Fig. E)

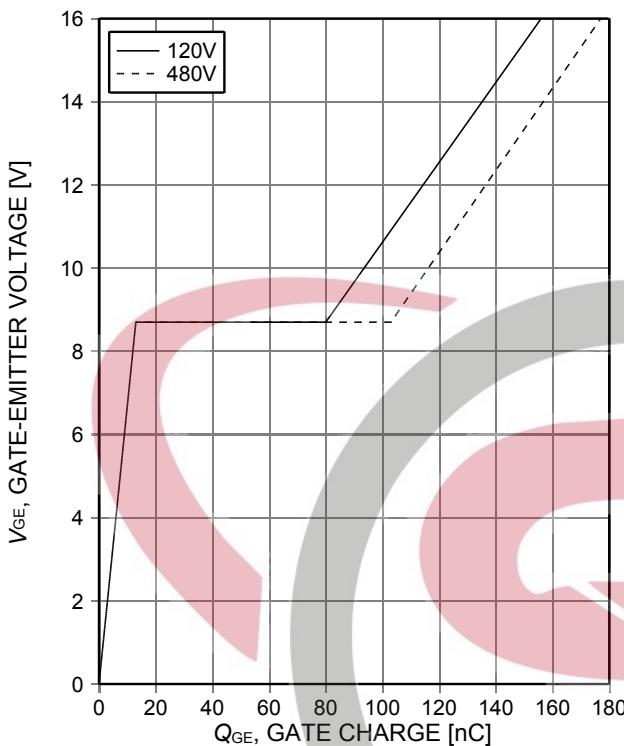


Figure 17. Typical gate charge  
( $I_C=30A$ )

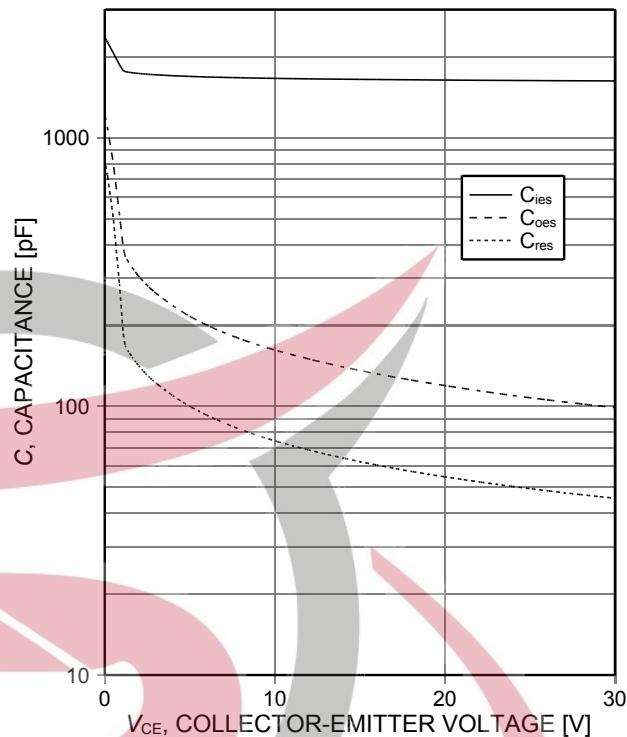


Figure 18. Typical capacitance as a function of  
collector-emitter voltage  
( $V_{GE}=0V$ ,  $f=1MHz$ )

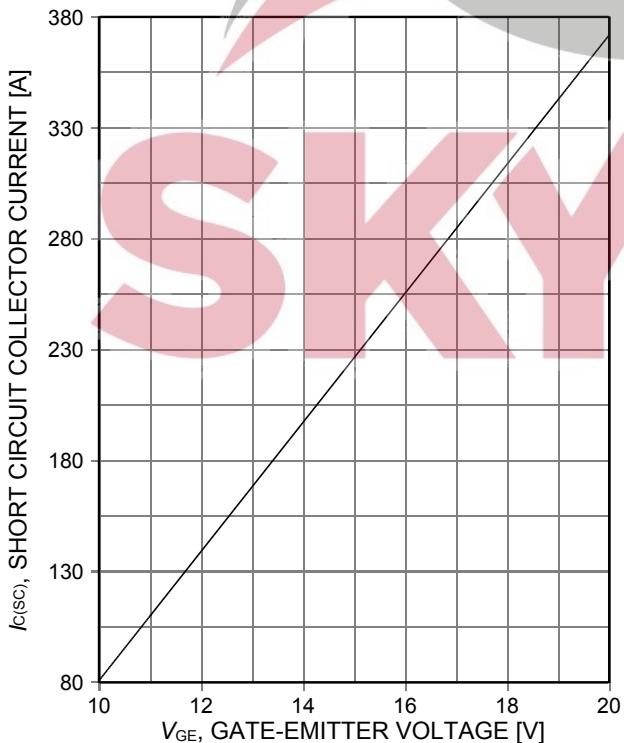


Figure 19. Typical short circuit collector current as a  
function of gate-emitter voltage  
( $V_{CE} \leq 400V$ , start at  $T_j = 25^\circ C$ )

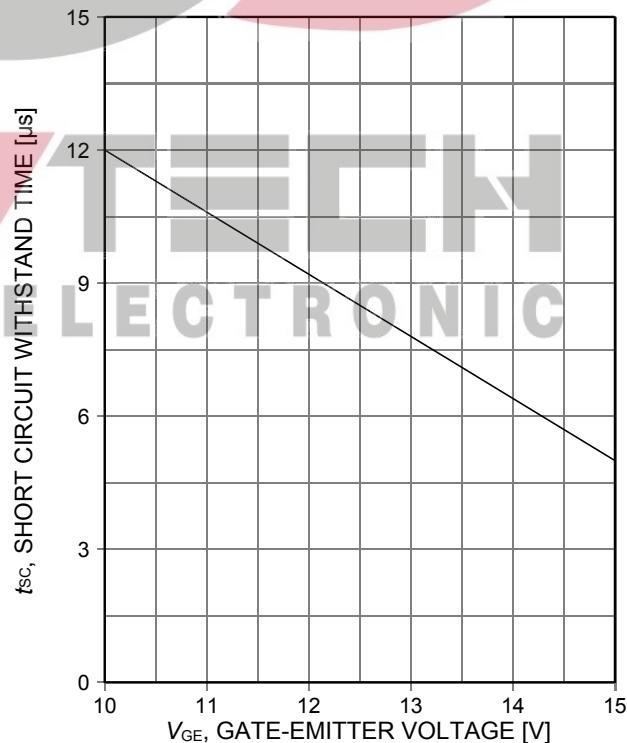


Figure 20. Short circuit withstand time as a function of  
gate-emitter voltage  
( $V_{CE} \leq 400V$ , start at  $T_j = 150^\circ C$ )

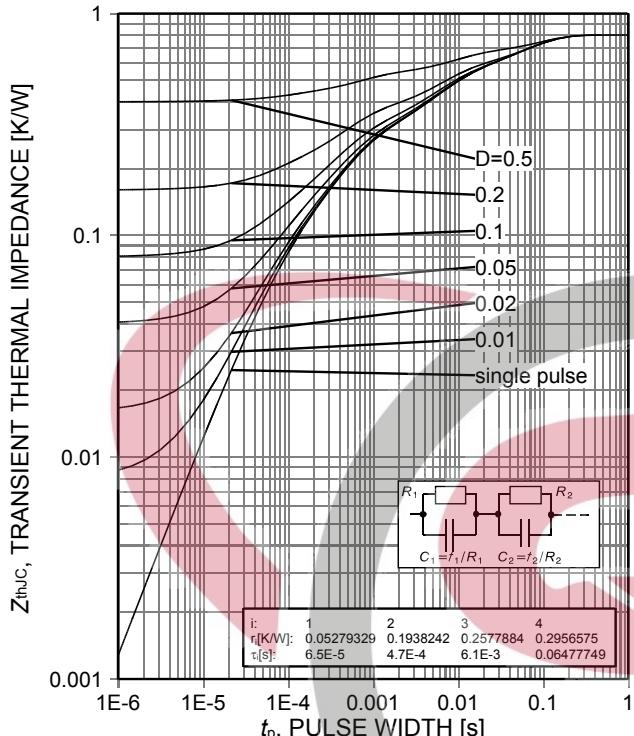


Figure 21. IGBT transient thermal impedance  
( $D=t_p/T$ )

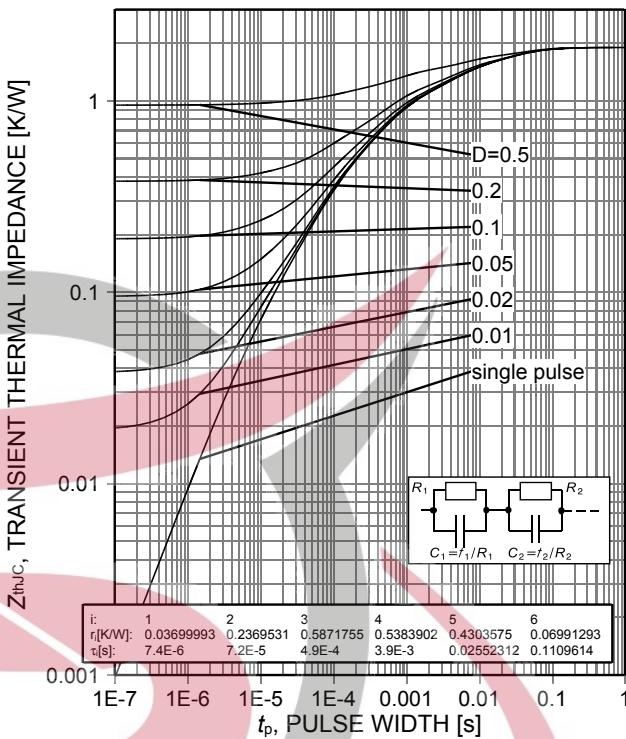


Figure 22. Diode transient thermal impedance as a function of pulse width  
( $D=t_p/T$ )

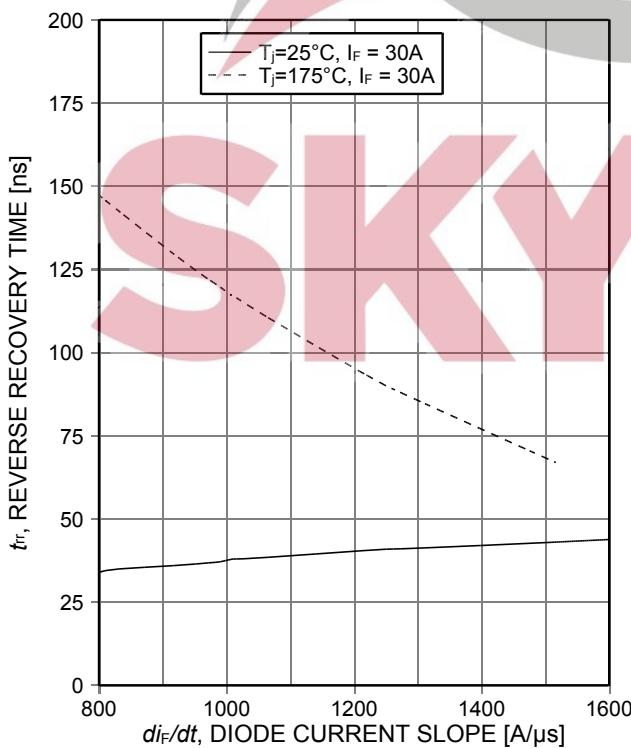


Figure 23. Typical reverse recovery time as a function of diode current slope  
( $V_R=400V$ )

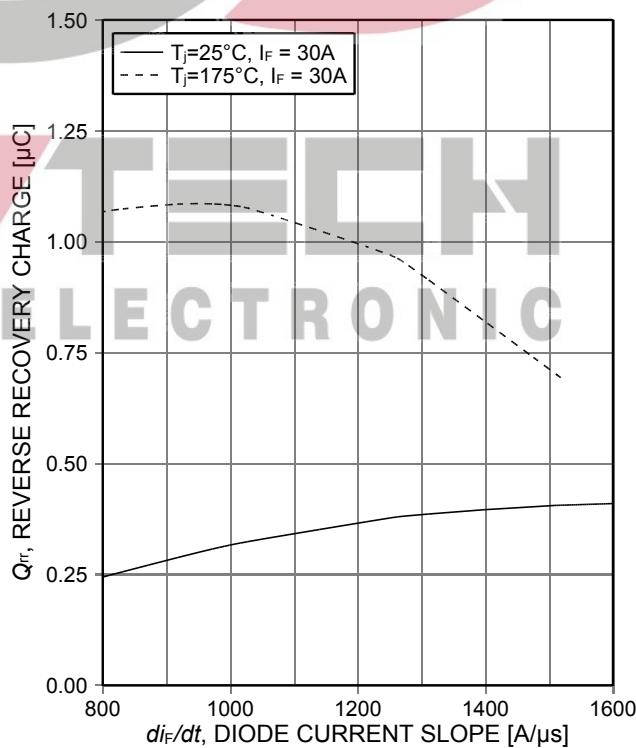
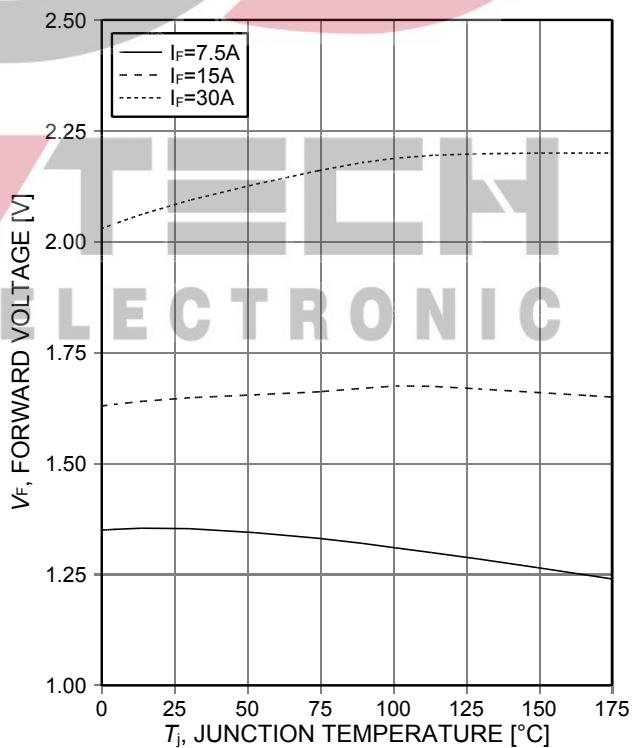
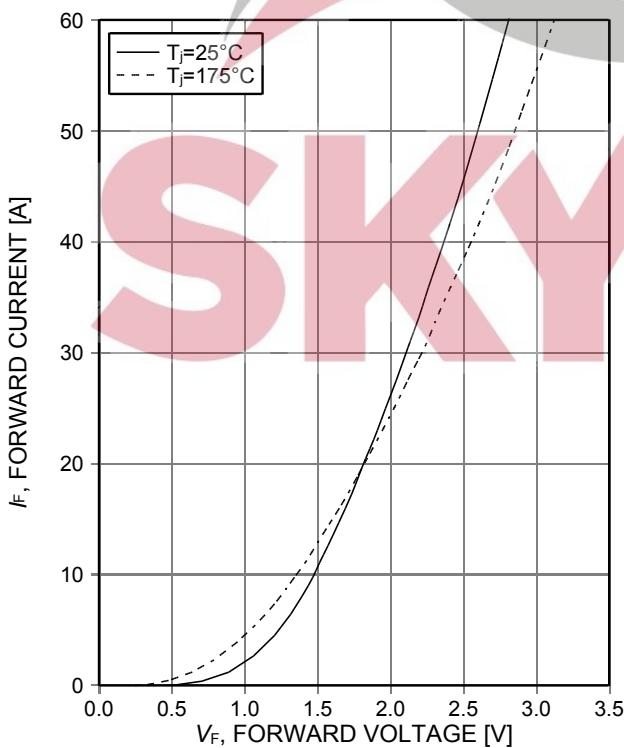
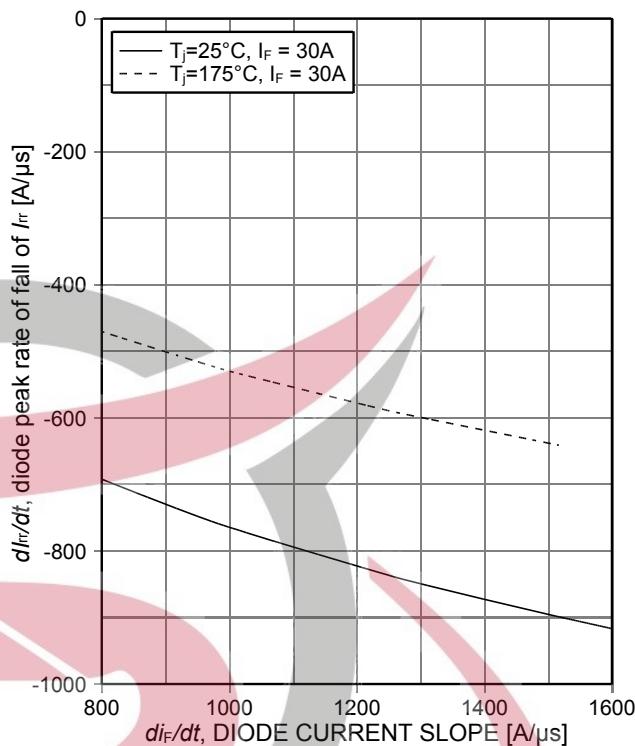
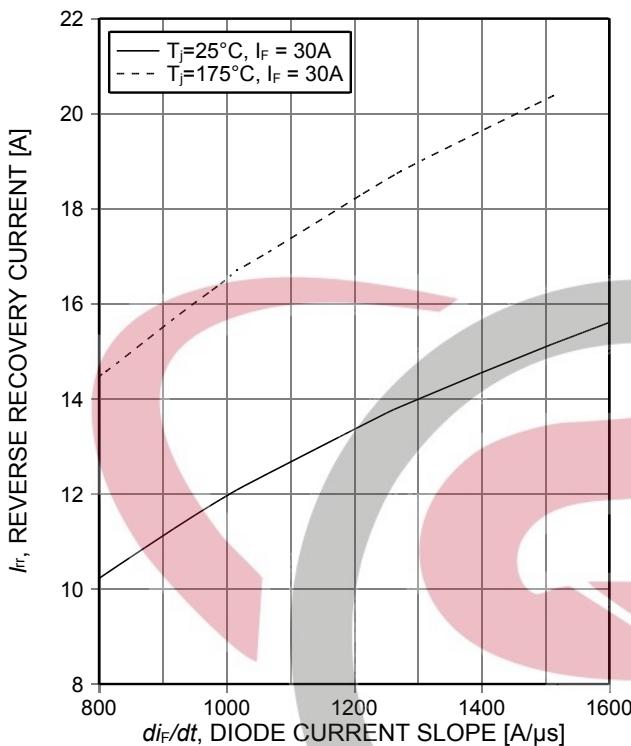
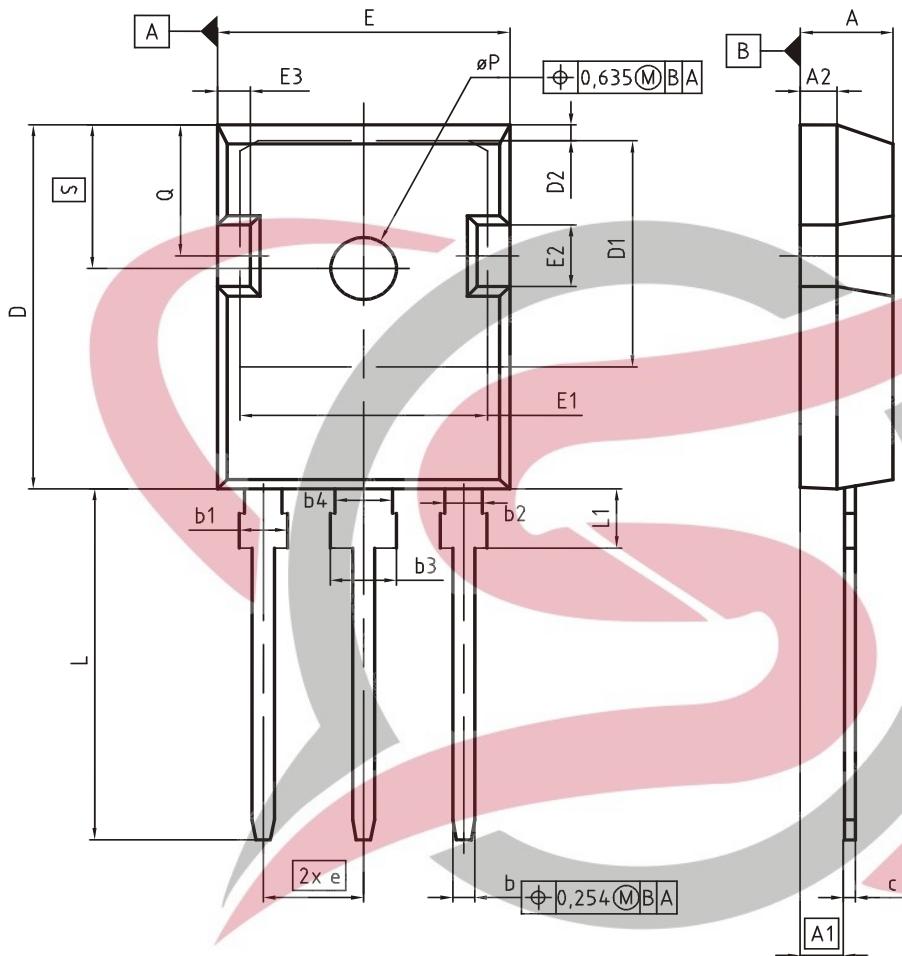


Figure 24. Typical reverse recovery charge as a function of diode current slope  
( $V_R=400V$ )



## PG-T0247-3



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
ØP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248

DOCUMENT NO.	Z8B00003327
SCALE	0 0 5 5 7.5mm
EUROPEAN PROJECTION	
ISSUE DATE	09-07-2010
REVISION	05

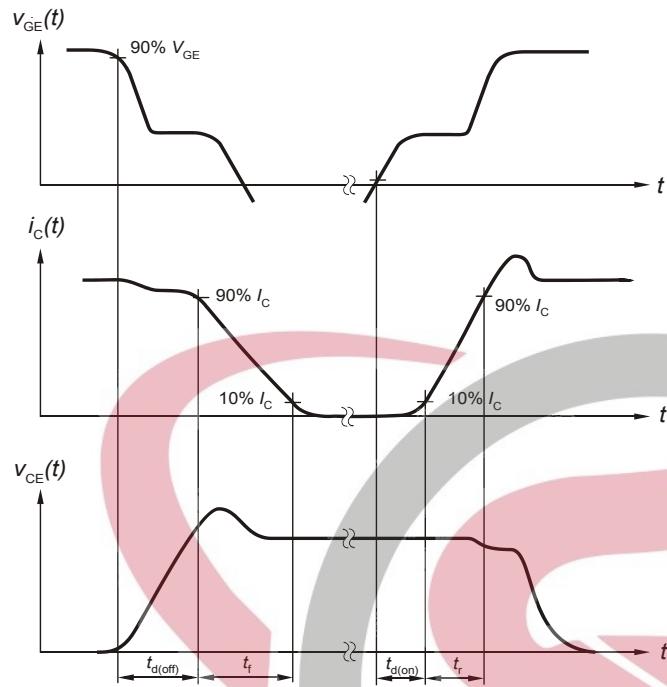


Figure A. Definition of switching times

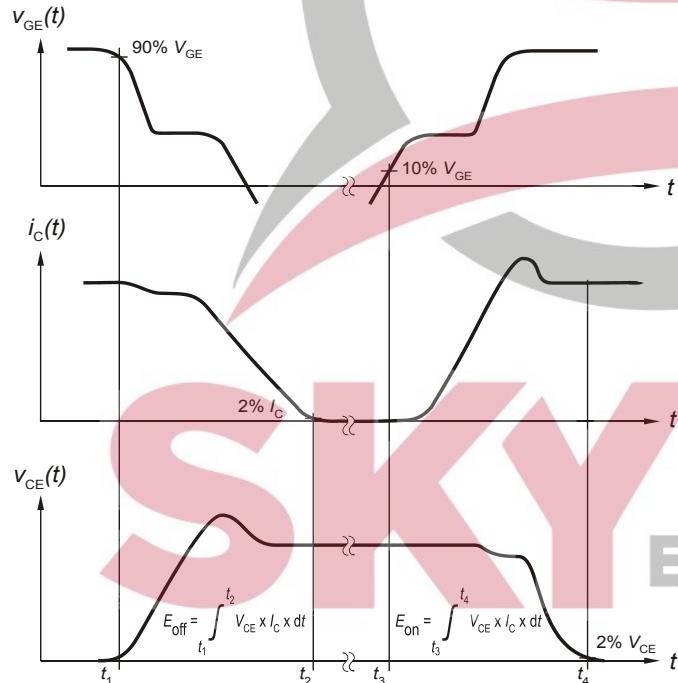


Figure B. Definition of switching losses

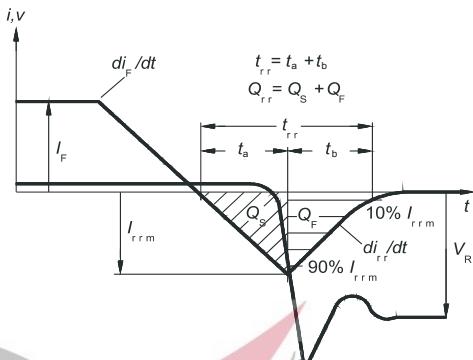


Figure C. Definition of diodes switching characteristics

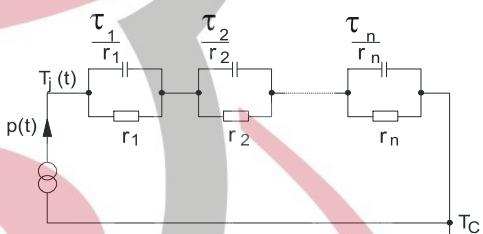


Figure D. Thermal equivalent circuit

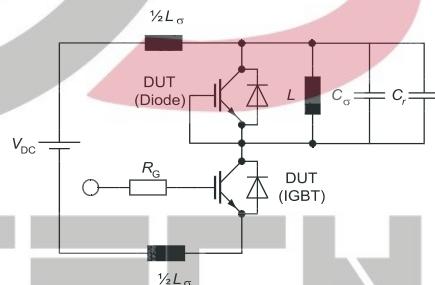


Figure E. Dynamic test circuit  
Parasitic inductance  $L_\sigma$ ,  
Parasitic capacitor  $C_\sigma$ ,  
Relief capacitor  $C_r$   
(only for ZVT switching)

## Revision History

IKW30N60H3

### Revision: 2014-03-12, Rev. 2.2

#### Previous Revision

Revision	Date	Subjects (major changes since last revision)
1.1	2010-02-01	-
1.2	2010-07-26	Preliminary datasheet
2.1	2013-12-09	New value IRmax limit at 175°C
2.2	2014-03-12	Max ratings Vce, Tvj ≥ 25°C

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